

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Do-Hyung KIM, et al.

Serial No.: 10/083,756 Examiner: Hu, Shouxiang

Filed: February 25, 2002 Group Art Unit: 2811

Confirmation No.: 2262

For: METHOD FOR FORMING LAYER FOR TRENCH ISOLATION
STRUCTURE

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Responsive to the Office Action, Paper No. 20070202, dated February 8, 2007, please amend the application as follows.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 7 of this paper.